RGS50TSX2DHR

1200V 25A Field Stop Trench IGBT

Datasheet

V_{CES}	1200V
I _{C (100°C)}	25A
V _{CE(sat) (Typ.)}	1.7V
P_D	395W

Outline TO-247N

Features

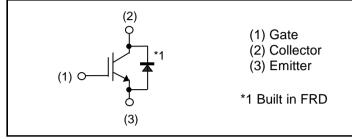
- 1) Low Collector Emitter Saturation Voltage
- 2) Short Circuit Withstand Time 10µs
- 3) Qualified to AEC-Q101
- 4) Built in Very Fast & Soft Recovery FRD
- 5) Pb free Lead Plating; RoHS Compliant

Application

General Inverter

for Automotive and Industrial Use

●Inner Circuit



Packaging Specifications

or deraging openitions					
	Packaging	Tube			
	Reel Size (mm)	-			
Tuno	Tape Width (mm)	-			
Туре	Basic Ordering Unit (pcs)	450			
	Packing Code	C11			
	Marking	RGS50TSX2D			

● Absolute Maximum Ratings (at T_C = 25°C unless otherwise specified)

Parameter		Symbol	Value	Unit
Collector - Emitter Voltage		V _{CES}	1200	V
Gate - Emitter Voltage		V_{GES}	±30	V
Collector Current	T _C = 25°C	I _C	50	А
Collector Current	T _C = 100°C	I _C	25	Α
Pulsed Collector Current		I _{CP} *1	75	Α
Diode Forward Current	T _C = 25°C	I _F	50	Α
	T _C = 100°C	l _F	25	Α
Diode Pulsed Forward Current		I _{FP} *1	75	Α
Power Dissipation	T _C = 25°C	P_{D}	395	W
	T _C = 100°C	P_{D}	197	W
Operating Junction Temperature		T _j	-40 to +175	°C
Storage Temperature		T _{stg}	-55 to +175	°C

^{*1} Pulse width limited by T_{jmax.}

●Thermal Resistance

Parameter	Symbol	Values			Unit
Falametei	Symbol	Min.	Тур.	Max.	Offic
Thermal Resistance IGBT Junction - Case	$R_{\theta(j-c)}$	-	-	0.38	°C/W
Thermal Resistance Diode Junction - Case	$R_{\theta(j-c)}$	-	ı	0.80	°C/W

●IGBT Electrical Characteristics (at T_j = 25°C unless otherwise specified)

Parameter	Symbol	Conditions		Unit		
- raiailletei	Symbol	Conditions	Min.	Тур.	Max.	Offic
Collector - Emitter Breakdown Voltage	BV _{CES}	$I_{C} = 10 \mu A, V_{GE} = 0 V$	1200	-	-	V
		$V_{CE} = 1200V, V_{GE} = 0V$				
Collector Cut - off Current	I _{CES}	T _j = 25°C	-	-	10	μΑ
		T _j = 175°C	-	2	-	mA
Gate - Emitter Leakage Current	I _{GES}	$V_{GE} = \pm 30V, V_{CE} = 0V$	-	ı	±500	nA
Gate - Emitter Threshold Voltage	$V_{GE(th)}$	$V_{CE} = 5V, I_{C} = 3.8 \text{mA}$	5.0	6.0	7.0	V
		$I_C = 25A, V_{GE} = 15V$				
Collector - Emitter Saturation Voltage	V _{CE(sat)}	T _j = 25°C	-	1.70	2.10	V
		T _j = 175°C	-	2.20	-	V

●IGBT Electrical Characteristics (at T_j = 25°C unless otherwise specified)

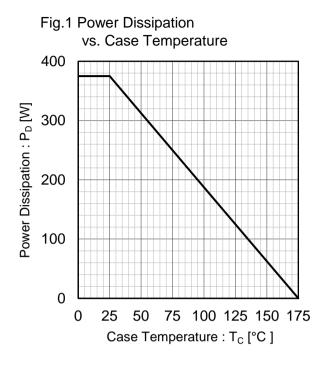
Danamatan	0	Conditions		l loit		
Parameter	Symbol		Min.	Тур.	Max.	Unit
Input Capacitance	C _{ies}	$V_{CE} = 30V$	-	2095	-	
Output Capacitance	C _{oes}	$V_{GE} = 0V$	-	166	-	pF
Reverse transfer Capacitance	C _{res}	f = 1MHz	-	12	-	
Total Gate Charge	Q_g	V _{CE} = 500V	-	67	-	
Gate - Emitter Charge	Q_ge	I _C = 25A	-	19	-	nC
Gate - Collector Charge	Q_{gc}	$V_{GE} = 15V$	-	25	-	
Turn - on Delay Time	t _{d(on)}		1	37	1	
Rise Time	t _r	$I_C = 25A, V_{CC} = 600V,$ $V_{GE} = 15V, R_G = 10\Omega,$	-	16	-	no
Turn - off Delay Time	t _{d(off)}	$T_i = 25^{\circ}C$	-	140	-	ns
Fall Time	t _f	Inductive Load	-	205	-	
Turn-on Switching Loss	E _{on}	*E _{on} include diode reverse recovery	-	1.40	-	- mJ
Turn-off Switching Loss	E _{off}	,	1	1.65	1	
Turn - on Delay Time	t _{d(on)}	I_C = 25A, V_{CC} = 600V, V_{GE} = 15V, R_G = 10 Ω , T_j = 175°C Inductive Load	-	36	-	
Rise Time	t _r		-	17	-	ns
Turn - off Delay Time	t _{d(off)}		1	170	1	
Fall Time	t _f		-	280	-	
Turn-on Switching Loss	E _{on}	*E _{on} include diode reverse recovery	-	1.50	-	mJ
Turn-off Switching Loss	E _{off}	1000100 1000019	1	2.20	1	IIIJ
Reverse Bias Safe Operating Area	RBSOA	$I_C = 75A$, $V_{CC} = 1050V$ $V_p = 1200V$, $V_{GE} = 15V$ $R_G = 50\Omega$, $T_j = 175^{\circ}C$	FULL SQUARE		-	
Short Circuit Withstand Time	t _{sc}	$V_{CC} \le 600V$ $V_{GE} = 15V, T_j = 25^{\circ}C$	10	-	-	μs
Short Circuit Withstand Time	t _{sc} *2	$V_{CC} \le 600V$ $V_{GE} = 15V, T_j = 150^{\circ}C$	8	-	-	μs

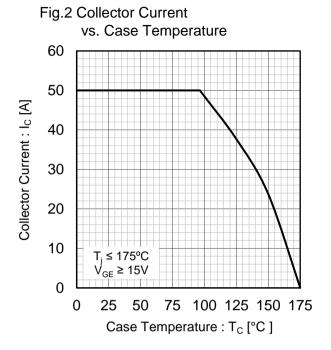
^{*2} Design assurance without measurement

•FRD Electrical Characteristics (at $T_j = 25^{\circ}C$ unless otherwise specified)

Parameter	Symbol	Conditions	Values			Unit
Parameter	Symbol		Min.	Тур.	Max.	Offic
Diode Forward Voltage	V _F	$I_{F} = 25A$ $T_{j} = 25^{\circ}C$ $T_{j} = 175^{\circ}C$	-	1.65 1.85	2.10	V
Diode Reverse Recovery Time	t _{rr}		-	182	-	ns
Diode Peak Reverse Recovery Current	I _{rr}	$I_F = 25A$ $V_{CC} = 600V$ $di_F/dt = 500A/\mu s$ $T_j = 25^{\circ}C$	-	15.7	-	А
Diode Reverse Recovery Charge	Q _{rr}		-	1.7	1	μC
Diode Reverse Recovery Energy	E _{rr}		-	422	-	μJ
Diode Reverse Recovery Time	t _{rr}	$I_F = 25A$ $V_{CC} = 600V$ $di_F/dt = 500A/\mu s$ $T_j = 175^{\circ}C$	-	248	-	ns
Diode Peak Reverse Recovery Current	I _{rr}		-	17.8	-	А
Diode Reverse Recovery Charge	Q _{rr}		_	2.7	-	μC
Diode Reverse Recovery Energy	E _{rr}		-	787	-	μJ

• Electrical Characteristic Curves





1000 10µs 100 Collector Current : I_C [A] 100µs 10 1 0.1 $T_{\rm C} = 25^{\circ}{\rm C}$ Single Pulse 0.01 10 100 1000 10000 Collector To Emitter Voltage: V_{CE} [V]

Fig.3 Forward Bias Safe Operating Area

100

Very 100

To 100

Fig.4 Reverse Bias Safe Operating Area

5/11

•Electrical Characteristic Curves

Fig.5 Typical Output Characteristics

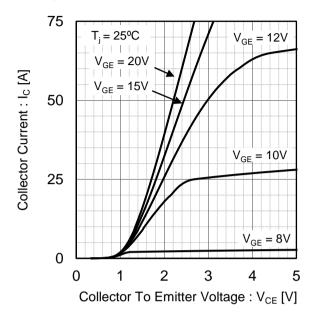


Fig.6 Typical Output Characteristics

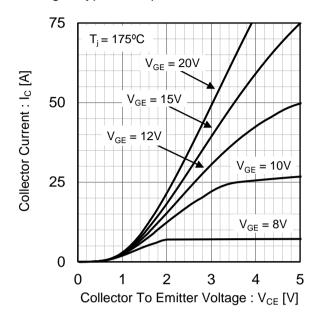


Fig.7 Typical Transfer Characteristics

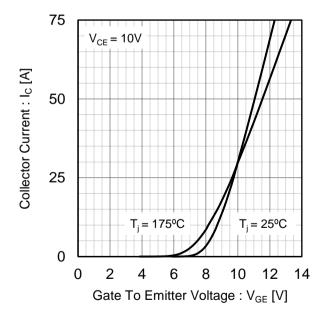
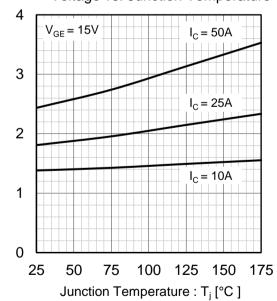


Fig.8 Typical Collector To Emitter Saturation Voltage vs. Junction Temperature



Collector To Emitter Saturation

Voltage: V_{CE(sat)} [V]

● Electrical Characteristic Curves

Fig.9 Typical Collector To Emitter Saturation Voltage vs. Gate To Emitter Voltage

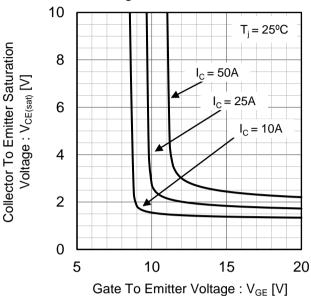


Fig.10 Typical Collector To Emitter Saturation Voltage vs. Gate To Emitter Voltage

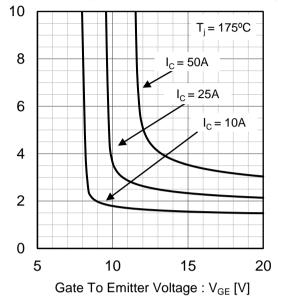


Fig.11 Typical Switching Time vs. Collector Current

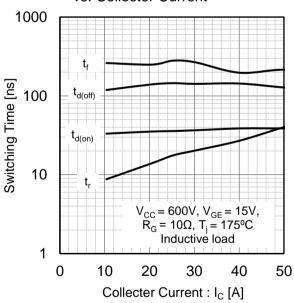
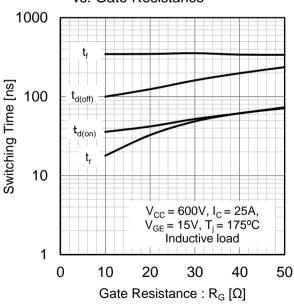


Fig.12 Typical Switching Time vs. Gate Resistance



Collector To Emitter Saturation

Voltage: V_{CE(sat)} [V]

• Electrical Characteristic Curves

Fig.13 Typical Switching Energy Losses vs. Collector Current 100 Switching Energy Losses [mJ] 10 E_{on} $\mathsf{E}_{\mathsf{off}}$ 1 V_{CC} = 600V, V_{GE} = 15V, R_{G} = 10 Ω , T_{j} = 175°C Inductive load 0.1 0 10 20 30 40 50

Collector Current : I_C [A]

vs. Gate Resistance 100 Switching Energy Losses [mJ] 10 E_{on} $\mathsf{E}_{\mathsf{off}}$ 1 $V_{CC} = 600V, V_{GE} = 15V, I_{C} = 25A, T_{j} = 175^{\circ}C$ Inductive load 0.1 0 10 20 30 40 50 Gate Resistance : $R_G[\Omega]$

Fig.14 Typical Switching Energy Losses

Fig.15 Typical Capacitance vs. Collector To Emitter Voltage 10000 \mathbf{C}_{ies} 1000 Capacitance [pF] 100 C_{oes} 10 f = 1MHz C_{res} $V_{GE} = 0V$ $T_{j} = 25^{\circ}C$ 1 0.01 0.1 10 100 Collector To Emitter Voltage: V_{CE} [V]

Fig.16 Typical Gate Charge 15 $V_{CC} = 300V$ Gate To Emitter Voltage: VGE [V] 10 $V_{CC} = 500V$ 5 $I_C = 25A$ $T_{i} = 25^{\circ}C$ 0 0 15 30 45 75 60 Gate Charge: Q_G [nQ]

ROHM

Electrical Characteristic Curves

Fig.17 Typical Diode Forward Current vs. Forward Voltage

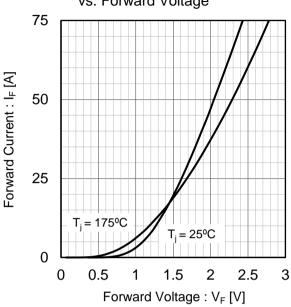


Fig.18 Typical Diode Reverce Recovery Time vs. Forward Current

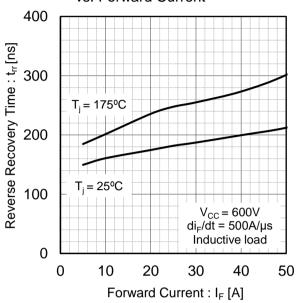


Fig.19 Typical Diode Reverse Recovery Current vs. Forward Current

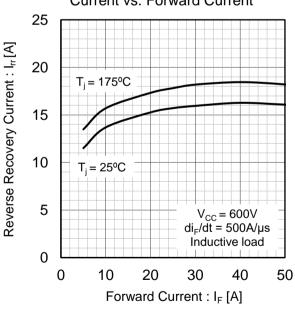
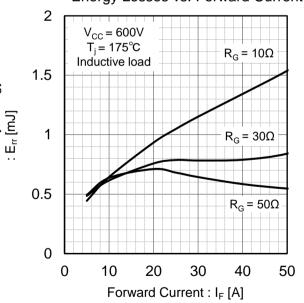


Fig.20 Typical Diode Reverse Recovery Energy Losses vs. Forward Current



Reverse Recovery Energy Losses

•Electrical Characteristic Curves

Fig.21 IGBT Transient Thermal Impedance

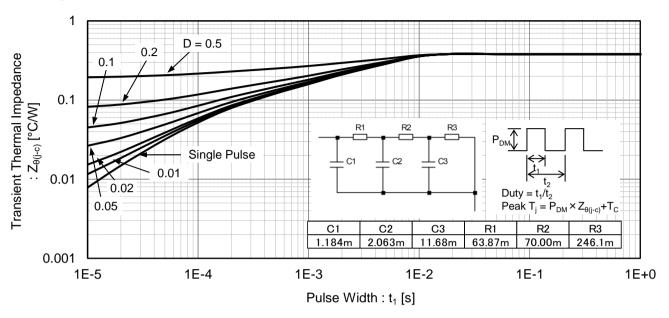
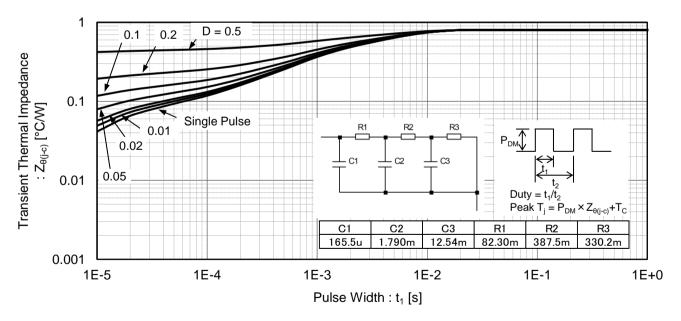


Fig.22 Diode Transient Thermal Impedance



●Inductive Load Switching Circuit and Waveform

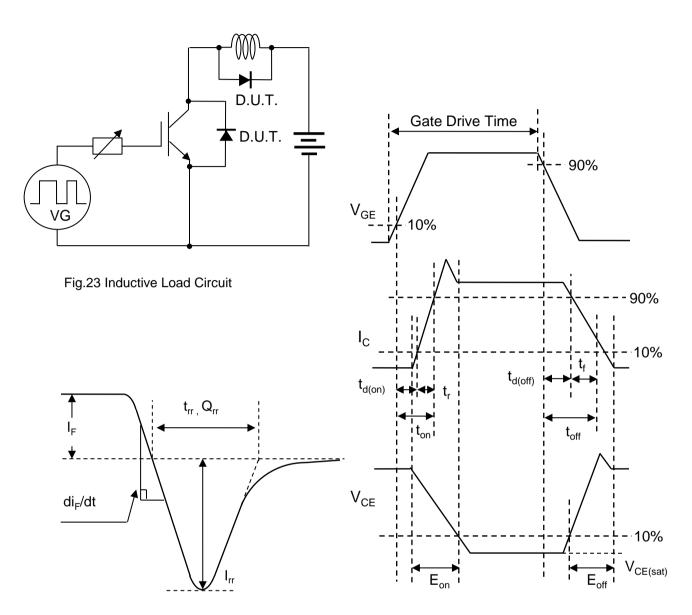


Fig.24 Diode Reverce Recovery Waveform

Fig.25 Inductive Load Waveform

Notes

- 1) The information contained herein is subject to change without notice.
- Before you use our Products, please contact our sales representative and verify the latest specifications.
- 3) Although ROHM is continuously working to improve product reliability and quality, semiconductors can break down and malfunction due to various factors.

 Therefore, in order to prevent personal injury or fire arising from failure, please take safety measures such as complying with the derating characteristics, implementing redundant and fire prevention designs, and utilizing backups and fail-safe procedures. ROHM shall have no responsibility for any damages arising out of the use of our Poducts beyond the rating specified by ROHM.
- 4) Examples of application circuits, circuit constants and any other information contained herein are provided only to illustrate the standard usage and operations of the Products. The peripheral conditions must be taken into account when designing circuits for mass production.
- 5) The technical information specified herein is intended only to show the typical functions of and examples of application circuits for the Products. ROHM does not grant you, explicitly or implicitly, any license to use or exercise intellectual property or other rights held by ROHM or any other parties. ROHM shall have no responsibility whatsoever for any dispute arising out of the use of such technical information.
- 6) The Products specified in this document are not designed to be radiation tolerant.
- 7) For use of our Products in applications requiring a high degree of reliability (as exemplified below), please contact and consult with a ROHM representative: transportation equipment (i.e. cars, ships, trains), primary communication equipment, traffic lights, fire/crime prevention, safety equipment, medical systems, servers, solar cells, and power transmission systems.
- 8) Do not use our Products in applications requiring extremely high reliability, such as aerospace equipment, nuclear power control systems, and submarine repeaters.
- 9) ROHM shall have no responsibility for any damages or injury arising from non-compliance with the recommended usage conditions and specifications contained herein.
- 10) ROHM has used reasonable care to ensure the accuracy of the information contained in this document. However, ROHM does not warrants that such information is error-free, and ROHM shall have no responsibility for any damages arising from any inaccuracy or misprint of such information.
- 11) Please use the Products in accordance with any applicable environmental laws and regulations, such as the RoHS Directive. For more details, including RoHS compatibility, please contact a ROHM sales office. ROHM shall have no responsibility for any damages or losses resulting non-compliance with any applicable laws or regulations.
- 12) When providing our Products and technologies contained in this document to other countries, you must abide by the procedures and provisions stipulated in all applicable export laws and regulations, including without limitation the US Export Administration Regulations and the Foreign Exchange and Foreign Trade Act.
- This document, in part or in whole, may not be reprinted or reproduced without prior consent of ROHM.



Thank you for your accessing to ROHM product informations. More detail product informations and catalogs are available, please contact us.

ROHM Customer Support System

http://www.rohm.com/contact/

General Precaution

- 1. Before you use our Products, you are requested to care fully read this document and fully understand its contents. ROHM shall not be in an y way responsible or liable for failure, malfunction or accident arising from the use of a ny ROHM's Products against warning, caution or note contained in this document.
- 2. All information contained in this docume nt is current as of the issuing date and subject to change without any prior notice. Before purchasing or using ROHM's Products, please confirm the latest information with a ROHM sale s representative.
- 3. The information contained in this doc ument is provided on an "as is" basis and ROHM does not warrant that all information contained in this document is accurate an d/or error-free. ROHM shall not be in an y way responsible or liable for any damages, expenses or losses incurred by you or third parties resulting from inaccuracy or errors of or concerning such information.

Rev.001